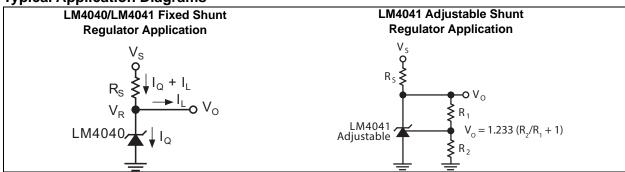
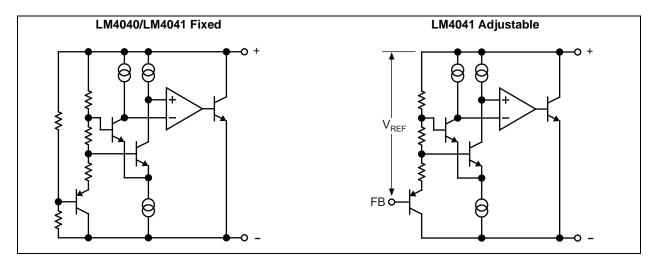
Typical Application Diagrams



Functional Block Diagrams



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Reverse Current	20 mA
Forward Current	10 mA
Maximum Output Voltage (LM4041-ADJ)	15V
Power Dissipation (T _A = +25°C; Note 1)	
ESD Susceptibility (HBM; Note 2)	
ESD Susceptibility (MM; Note 2)	200V

Operating Ratings ‡

Reverse Current (LM4040-2.5)	60 µA to 15 mA
Reverse Current (LM4040-4.1)	
Reverse Current (LM4040-5.0)	•
Reverse Current (LM4041-1.2)	
Reverse Current (LM4041-ADJ)	
Output Voltage Range (LM4041-ADJ)	

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

‡ Notice: The device is not guaranteed to function outside its operating ratings.

- Note 1: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} (maximum junction temperature), Θ_{JA} (junction-to-ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{DMAX} = (T_{JMAX} T_A)/\Theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower. For the LM4040 and LM4041, $T_{JMAX} = +125$ °C and the typical thermal resistance, when board-mounted, is +326°C/W for the SOT-23 package.
 - 2: Devices are ESD sensitive. Handling precautions are recommended. Human body model, 1.5 k Ω in series with 100 pF. The machine model is a 200 pF capacitor discharged directly into each pin.

LM4040-2.5 ELECTRICAL CHARACTERISTICS (Note 1)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
LM4040C			•		•	
Reverse-Breakdown Voltage	V_{R}	_	2.500	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±12	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±29	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	60	μΑ	T _A = +25°C
		_		65		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±20	1	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient		_	±15	±100		I _R = 1 mA
Cocincient		_	±15	_		I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$	_	0.3	0.8	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $T_A = +25^{\circ}\text{C}$
Current Change		_	_	1.0		I _{RMIN} ≤ I _R ≤ 1 mA
		_	2.5	6.0		1 mA \leq I _R \leq 15 mA, T _A = +25°C
		_		8.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z _R	_	0.3	0.9	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	_	35	l	μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA
LM4040D						
Reverse-Breakdown Voltage	V_{R}	_	2.500	1	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_		±25	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_		±49	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	65	μΑ	T _A = +25°C
				70		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$		±20		ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient			±15	±150		I _R = 1 mA
C C C MOIOIN			±15			I _R = 100 μA, T _A = +25°C

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/}^{\circ}\text{C} \times 65^{\circ}\text{C}$

LM4040-2.5 ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$	_	0.3	1.0	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $T_A = +25^{\circ}\text{C}$
Current Change		_	_	1.2		I _{RMIN} ≤ I _R ≤ 1 mA
		_	2.5	8.0		1 mA ≤ I _R ≤ 15 mA, T _A = +25°C
		1	_	10.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z _R	_	0.3	1.1	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	_	35	_	μV _{RMS}	I _R = 100 μA, 10 Hz ≤ f ≤ 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV _R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance ±[(ΔV_R/ΔT)(65°C)(V_R)]. ΔV_R/ΔT is the V_R temperature coefficient, 65°C is the temperature range from –40°C to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4040-4.1 ELECTRICAL CHARACTERISTICS (Note 1)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
LM4040C						
Reverse-Breakdown Voltage	V _R	_	4.096	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±20	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±47	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	50	68	μΑ	T _A = +25°C
		_	_	73		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±30	_	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient		_	±20	±100	1	I _R = 1 mA
Coefficient		_	±20	_	1	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$	_	0.5	0.9	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $T_A = +25^{\circ}\text{C}$
Current Change		_	_	1.2		I _{RMIN} ≤ I _R ≤ 1 mA
		_	3.0	7.0		1 mA \leq I _R \leq 15 mA, T _A = +25°C
		_	_	10.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z _R	_	0.5	1.0	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	_	80		μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA
LM4040D						
Reverse-Breakdown Voltage	V_{R}	_	4.096	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±41	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±81	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}		50	73	μA	T _A = +25°C
				78		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±30	_	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient			±20	±150		I _R = 1 mA
Cocinoloni			±20			I _R = 100 μA, T _A = +25°C

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4040-4.1 ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$		0.5	1.2	mV	$I_{RMIN} \le I_{R} \le 1 \text{ mA},$ $T_{A} = +25^{\circ}\text{C}$
Current Change		-	1	1.5		I _{RMIN} ≤ I _R ≤ 1 mA
		_	3.0	9.0		1 mA ≤ I _R ≤ 15 mA, T _A = +25°C
		1	1	13.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z_R	-	0.5	1.3	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	-	80	_	μV _{RMS}	I _R = 100 μA, T _A = +25°C 10 Hz ≤ f ≤ 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: ±1.15% = ±0.5% ±100 ppm/°C × 65°C
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4040-5.0 ELECTRICAL CHARACTERISTICS (Note 1)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
LM4040C						
Reverse-Breakdown Voltage	V_{R}	_	5.000	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±25	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±58	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	54	74	μΑ	T _A = +25°C
		_	_	80		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±30	1	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient		_	±20	±100		I _R = 1 mA
Cocincient		_	±20	1		I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$	_	0.5	1.0	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $T_A = +25^{\circ}\text{C}$
Current Change		_	_	1.4		$I_{RMIN} \le I_R \le 1 \text{ mA}$
		_	3.5	8.0		1 mA ≤ I _R ≤ 15 mA, T _A = +25°C
		_	_	12.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z _R	_	0.5	1.1	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	_	80		μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120		ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA
LM4040D						
Reverse-Breakdown Voltage	V_{R}	_	5.000	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±50	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±99	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	54	79	μΑ	T _A = +25°C
			_	85		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±30	_	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient			±20	±150		I _R = 1 mA
- Cocinoloni			±20			I _R = 100 μA, T _A = +25°C

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4040-5.0 ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$		0.5	1.3	mV	$I_{RMIN} \le I_{R} \le 1 \text{ mA},$ $T_{A} = +25^{\circ}\text{C}$
Current Change		-	1	1.8		I _{RMIN} ≤ I _R ≤ 1 mA
		_	3.5	10.0		1 mA \leq I _R \leq 15 mA, T _A = +25°C
		1	1	15.0		1 mA ≤ I _R ≤ 15 mA
Reverse Dynamic Impedance	Z_R	-	0.5	1.5	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	-	80	_	μV _{RMS}	I _R = 100 μA, T _A = +25°C, 10 Hz ≤ f ≤ 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: ±1.15% = ±0.5% ±100 ppm/°C × 65°C
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4041-1.2 ELECTRICAL CHARACTERISTICS (Note 1)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
LM4041C						
Reverse-Breakdown Voltage	V_{R}	_	1.225	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±6	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±14	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	60	μΑ	T _A = +25°C
		_	_	65		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$	_	±20	1	ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient		_	±15	±100		I _R = 1 mA
Cocincient		_	±15			I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$		0.7	1.5	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $T_A = +25^{\circ}\text{C}$
Current Change		_		2.0		I _{RMIN} ≤ I _R ≤ 1 mA
		_	4.0	6.0		1 mA \leq I _R \leq 12 mA, T _A = +25°C
		_	_	8.0		1 mA ≤ I _R ≤ 12 mA
Reverse Dynamic Impedance	Z _R		0.5	1.5	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N		20		μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_{R}	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA
LM4041D						
Reverse-Breakdown Voltage	V_{R}	_	1.225	_	V	I _R = 100 μA, T _A = +25°C
Reverse-Breakdown Voltage		_	_	±12	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±24		I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	65	μΑ	T _A = +25°C
		_	_	70		_
Average Reverse-Breakdown	$\Delta V_R/\Delta_T$		±20		ppm/°C	I _R = 10 mA, T _A = +25°C
Voltage Temperature Coefficient		_	±15	±150		I _R = 1 mA
C C C MOIOIN			±15	_		I _R = 100 μA, T _A = +25°C

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4041-1.2 ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40° C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Reverse-Breakdown Voltage Change with Operating	$\Delta V_R / \Delta I_R$		0.7	2.0	mV	$I_{RMIN} \le I_{R} \le 1 \text{ mA},$ $T_{A} = +25^{\circ}\text{C}$
Current Change		-	1	2.5		I _{RMIN} ≤ I _R ≤ 1 mA
		_	2.5	8.0		1 mA \leq I _R \leq 12 mA, T _A = +25°C
		1	1	10.0		1 mA ≤ I _R ≤ 12 mA
Reverse Dynamic Impedance	Z_R	-	0.5	2.0	Ω	I _R = 1 mA, f = 120 Hz, I _{AC} = 0.1 I _R , T _A = +25°C
Wideband Noise	e _N	-	20	_	μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

LM4041-ADJ ELECTRICAL CHARACTERISTICS (Note 1)

 T_A = Operating Temperature Range, T_A = T_J = -40°C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
LM4041C						
Reverse-Breakdown Voltage	V_{R}	_	1.233	_	V	I _R = 100 μA, V _{OUT} = 5V
Reverse-Breakdown Voltage		_	_	±6.2	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±14	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	60	μA	T _A = +25°C
		_	_	65		_
Reference Voltage Change with Operating Current	ΔV _{REF} / ΔI _R	_	0.7	1.5	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $V_{OUT} \ge 1.6 \text{V (Note 3)}, T_A = +25^{\circ}\text{C}$
		_	_	2.0		$I_{RMIN} \le I_R \le 1 \text{ mA},$ $V_{OUT} \ge 1.6V \text{ (Note 3)}$
		_	2.0	4.0		1 mA \leq I _R \leq 12 mA, V _{OUT} \geq 1.6V (Note 3), T _A = +25°C
		_	_	6.0		1 mA ≤ I _R ≤ 12 mA, V _{OUT} ≥ 1.6V (Note 3)
Reference Voltage Change	ΔV _{REF} /		-1.55	-2.0	mV/V	I _R = 1 mA, T _A = +25°C
with Output Voltage Change	ΔV _O		_	-2.5		I _R = 1 mA
Feedback Current	I _{FB}	_	60	100	nA	T _A = +25°C
		_	_	120		_
Average Reference Voltage Temperature Coefficient	ΔV _{REF} / ΔT	_	±20	_	ppm/°C	V_{OUT} = 5V, I_R = 10 mA, T_A = +25°C
		_	±15	±100		V_{OUT} = 5V, I_R = 1 mA
		_	±15	_		V_{OUT} = 5V, I_R = 100 μ A, T_A = +25°C
Dynamic Output Impedance	Z _{OUT}	_	0.3	_	Ω	I_R = 1 mA, f = 120 Hz, T_A = +25°C, I_{AC} = 0.1 I_R , V_{OUT} = V_{REF}
		_	_	2.0		V _{OUT} = 10V, T _A = +25°C
Wideband Noise	e _N	_	20	_	μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

Example: The C-grade LM4040-2.5 has an overtemperature Reverse-Breakdown Voltage tolerance of $\pm 2.5 \times 1.15\% = \pm 29$ mV.

3: When V_{OUT} ≤ 1.6V, the LM4041-ADJ must operate at reduced I_R. This is caused by the series resistance of the die attach between the die (-) output and the package (-) output pin. See the Output Saturation curve in the Typical Performance Curves section.

LM4041-ADJ ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40°C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Reverse-Breakdown Voltage Long-Term Stability	ΔV _R	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA
LM4041D						
Reverse-Breakdown Voltage	V_R	_	1.233	_	V	I _R = 100 μA, V _{OUT} = 5V
Reverse-Breakdown Voltage		_	_	±12	mV	I _R = 100 μA, T _A = +25°C
Tolerance (Note 2)		_	_	±24	mV	I _R = 100 μA
Minimum Operating Current	I _{RMIN}	_	45	65	μΑ	T _A = +25°C
		_	_	70		_
Reference Voltage Change with Operating Current	ΔV _{REF} / ΔI _R	_	0.7	2.0	mV	$I_{RMIN} \le I_R \le 1 \text{ mA},$ $V_{OUT} \ge 1.6 \text{V (Note 3)},$ $T_A = +25 ^{\circ}\text{C}$
		_	_	2.5		$I_{RMIN} \le I_R \le 1 \text{ mA},$ $V_{OUT} \ge 1.6V \text{ (Note 3)}$
		_	2.0	6.0		1 mA ≤ I_R ≤ 12 mA, V_{OUT} ≥ 1.6V (Note 3), T_A = +25°C
		_	_	8.0		1 mA ≤ I _R ≤ 12 mA, V _{OUT} ≥ 1.6V (Note 3)
Reference Voltage Change	ΔV_{REF}	_	-1.55	-2.5	mV/V	I _R = 1 mA, T _A = +25°C
with Output Voltage Change	ΔV _O	_	_	-3.0		I _R = 1 mA
Feedback Current	I _{FB}	_	60	150	nA	T _A = +25°C
		_	_	200		_
Average Reference Voltage Temperature Coefficient	ΔV _{REF} / ΔT	_	±20	_	ppm/°C	V_{OUT} = 5V, I_{R} = 10 mA, T_{A} = +25°C
		_	±15	±150		V_{OUT} = 5V, I_R = 1 mA
		_	±15	_		V_{OUT} = 5V, I_{R} = 100 μ A, T_{A} = +25°C
Dynamic Output Impedance	Z _{OUT}	_	0.3	_	Ω	I_R = 1 mA, f = 120 Hz, T_A = +25°C, I_{AC} = 0.1 I_R , V_{OUT} = V_{REF}
		_	_	2.0		V _{OUT} = 10V, T _A = +25°C

- **Note 1:** Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance ±[(ΔV_R/ΔT)(65°C)(V_R)]. ΔV_R/ΔT is the V_R temperature coefficient, 65°C is the temperature range from –40°C to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

Example: The C-grade LM4040-2.5 has an overtemperature Reverse-Breakdown Voltage tolerance of $\pm 2.5 \times 1.15\% = \pm 29$ mV.

3: When $V_{OUT} \le 1.6V$, the LM4041-ADJ must operate at reduced I_R . This is caused by the series resistance of the die attach between the die (-) output and the package (-) output pin. See the Output Saturation curve in the Typical Performance Curves section.

LM4041-ADJ ELECTRICAL CHARACTERISTICS (Note 1) (CONTINUED)

 T_A = Operating Temperature Range, T_A = T_J = -40°C to +85°C, unless noted.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Wideband Noise	e _N	ı	20		μV _{RMS}	$I_R = 100 \mu A, T_A = +25^{\circ}C,$ 10 Hz \le f \le 10 kHz
Reverse-Breakdown Voltage Long-Term Stability	ΔV_{R}	_	120	_	ppm	t = 1000 hrs., T _A = +25°C ±0.1°C, I _R = 100 μA

- Note 1: Specification for packaged product only.
 - 2: The boldface (overtemperature) limit for Reverse-Breakdown Voltage Tolerance is defined as the room temperature Reverse-Breakdown Voltage Tolerance $\pm [(\Delta V_R/\Delta T)(65^{\circ}C)(V_R)]$. $\Delta V_R/\Delta T$ is the V_R temperature coefficient, 65°C is the temperature range from $-40^{\circ}C$ to the reference point of 25°C, and V_R is the reverse-breakdown voltage. The total overtemperature tolerance for the different grades follows:
 - a. C-grade: $\pm 1.15\% = \pm 0.5\% \pm 100 \text{ ppm/°C} \times 65^{\circ}\text{C}$
 - b. D-grade: $\pm 1.98\% = \pm 1.0\% \pm 150 \text{ ppm/°C} \times 65^{\circ}\text{C}$

Example: The C-grade LM4040-2.5 has an overtemperature Reverse-Breakdown Voltage tolerance of $\pm 2.5 \times 1.15\% = \pm 29$ mV.

3: When V_{OUT} ≤ 1.6V, the LM4041-ADJ must operate at reduced I_R. This is caused by the series resistance of the die attach between the die (-) output and the package (-) output pin. See the Output Saturation curve in the Typical Performance Curves section.

TEMPERATURE SPECIFICATIONS (Note 1)

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Operating Temperature Range	T _A	-4 0	_	+85	°C	_
Storage Temperature	T _S	-65	_	+150	°C	_
Lead Temperature	_	_	+215	_	°C	Vapor phase, 60s
Lead Temperature	_	_	+220	_	°C	Infrared, 15s
Package Thermal Resistance						
3-Pin SOT-23	Θ_{JA}	_	+326	_	°C/W	_

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

Test Circuits

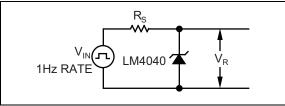


FIGURE 1-1: LM4040.

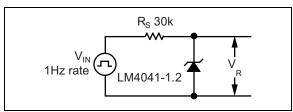


FIGURE 1-2: LM4041.

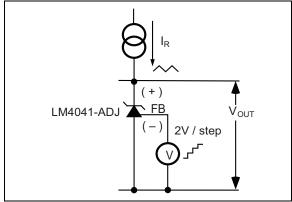


FIGURE 1-3: Reverse Characteristics
Test Circuit.

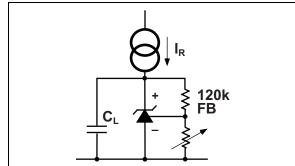


FIGURE 1-4: Output Impedance vs. Frequency Test Circuit.

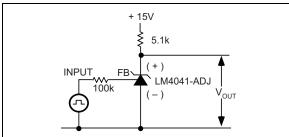


FIGURE 1-5: Large Signal Response Test Circuit.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

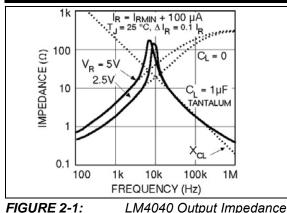


FIGURE 2-1: LM40 vs. Frequency.

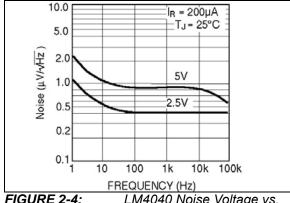


FIGURE 2-4: LM4040 Noise Voltage vs. Frequency.

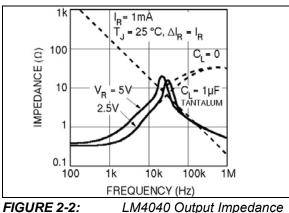


FIGURE 2-2: It vs. Frequency.

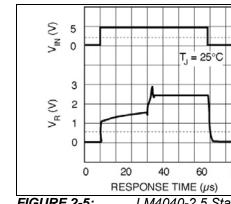


FIGURE 2-5: LM4040-2.5 Start-Up Characteristics ($R_S = 30 \text{ k}\Omega$).

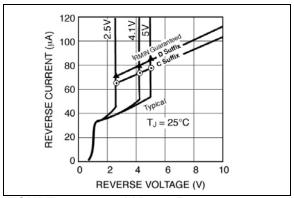


FIGURE 2-3: LM4040 Reverse Characteristics and Minimum Operating Current.

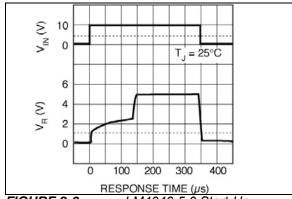


FIGURE 2-6: LM4040-5.0 Start-Up Characteristics ($R_S = 30 \text{ k}\Omega$).

-40°C

10

2

0

0

10

VOLTAGE (V)

FIGURE 2-10:

Response.

оитрит

20

RESPONSE TIME (µs)

30

LM4041 Large Signal

LM4041-ADJ

T_J = -40°C.

25°C 85°C

40°C

40

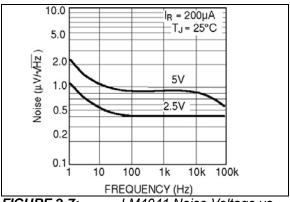
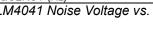


FIGURE 2-7: Frequency.

LM4041 Noise Voltage vs.



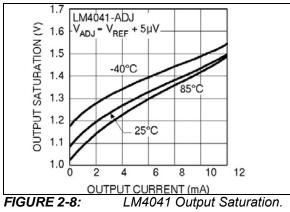


FIGURE 2-8:

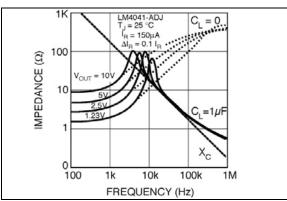


FIGURE 2-9:

LM4041 Output Impedance

vs. Frequency.

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

Pin Number Fixed	Pin Number Adjustable	Pin Name	Description
1	2	+	Cathode. Connect to positive voltage.
_	1	FB	Feedback. Connect to a resistive divider network to set the output voltage.
2	3	_	Anode. Connect to negative voltage.
3	_	NC	Not internally connected. This pin must be left floating or connected to –.

4.0 APPLICATION INFORMATION

The stable operation of the LM4040 and LM4041 references require an external capacitor greater than 10 nF connected between the (+) and (–) pins. Bypass capacitors with values between 100 pF and 10 nF have been found to cause the devices to exhibit instabilities.

4.1 Schottky Diode

LM4040-x.x and LM4041-1.2 in the SOT-23 package have a parasitic Schottky diode between Pin 2 (–) and Pin 3 (die attach interface connect). Pin 3 of the SOT-23 package must float or be connected to Pin 2. The LM4041-ADJ use Pin 3 as the (–) output.

4.2 Conventional Shunt Regulator

In a conventional shunt regulator application (see Figure 5-1), an external series resistor (R_S) is connected between the supply voltage and the LM4040-x.x or LM4041-1.2 reference. R_S determines the current that flows through the load (I_L) and the reference (I_Q). Because load current and supply voltage may vary, R_S should be small enough to supply at least the minimum acceptable I_Q to the reference even when the supply voltage is at its minimum and the load current is at its maximum value. When the supply voltage is at its minimum, R_S should be large enough so that the current flowing through the LM4040-x.x is less than 15 mA, and the current flowing through the LM4041-1.2 or LM4041-ADJ is less than 12 mA.

 R_S is determined by the supply voltage (V_S), the load and operating current, (I_L and I_Q), and the reference's reverse breakdown voltage (V_R):

EQUATION 4-1:

$$R_S = \frac{(V_S - V_R)}{(I_L + I_O)}$$

4.3 Adjustable Regulator

The LM4041-ADJ's output voltage can be adjusted to any value between 1.24V and 10V. It is a function of the internal reference voltage (V_{REF}) and the ratio of the external feedback resistors as shown in Figure 5-2. The output is found using the following equation:

EQUATION 4-2:

$$V_O = V_{REF}[(R2/R1) + 1]$$

Where:

V_O Desired Output Voltage

The actual value of the internal V_{REF} is a function of V_{O} . The corrected V_{REF} is determined by:

EQUATION 4-3:

$$V_{REF} = V_O \times \left(\frac{\Delta V_{REF}}{\Delta V_O}\right) + V_Y$$

Where:

V_O Desired Output Voltage

 $\Delta V_{REF}/\Delta V_O$ is found in the Electrical Characteristics section and is typically –1.3 mV/V and V_Y is equal to 1.233V. Replace the value of V_{REF} in Equation 4-2 with the value V_{REF} found using Equation 4-3.

Note that actual output voltage can deviate from that predicted using the typical $\Delta V_{REF}/\Delta V_O$ in Equation 4-3; for C-grade parts, the worst case $\Delta V_{REF}/\Delta V_O$ is – 2.5 mV/V and V_Y = 1.248V.

The following example shows the difference in output voltage resulting from the typical and worst case values of $\Delta V_{RFF}/\Delta V_O$.

Let V_O = +9V. Using the typical values of $\Delta V_{REF}/\Delta V_O$, V_{REF} is 1.223V. Choosing a value of R1 = 10 k Ω , R2 = 63.272 k Ω . Using the worst case $\Delta V_{REF}/\Delta V_O$ for the C-grade and D-grade parts, the output voltage is actually 8.965V and 8.946V respectively. This results in possible errors as large as 0.39% for the C-grade parts and 0.59% for the D-grade parts. Once again, resistor values found using the typical value of $\Delta V_{REF}/\Delta V_O$ will work in most cases, requiring no further adjustment.

5.0 TYPICAL APPLICATION CIRCUITS

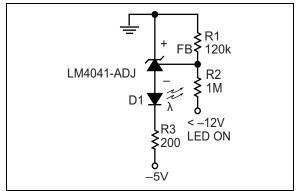


FIGURE 5-1: Voltage Level Detector.

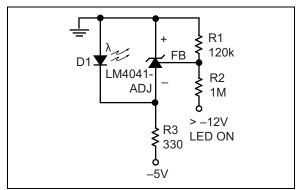


FIGURE 5-2: Voltage Level Detector.

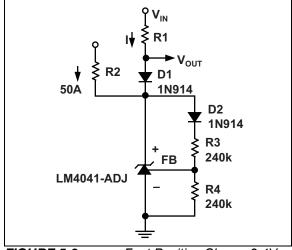


FIGURE 5-3: Fast Positive Clamp, 2.4V + ΔV_{D1} .

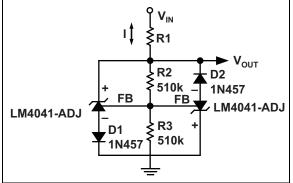


FIGURE 5-4: Bidirectional Clamp ±2.4V.

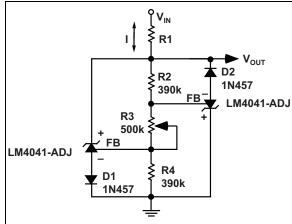


FIGURE 5-5: Bidirectional Adjustable Clamp ±1.8V to ±2.4V.

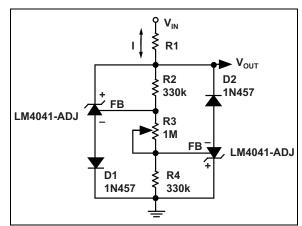


FIGURE 5-6: Bidirectional Adjustable Clamp ±2.4V to ±6V.

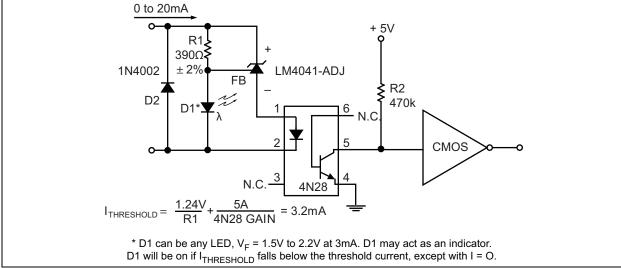


FIGURE 5-7: Floating Current Detector.

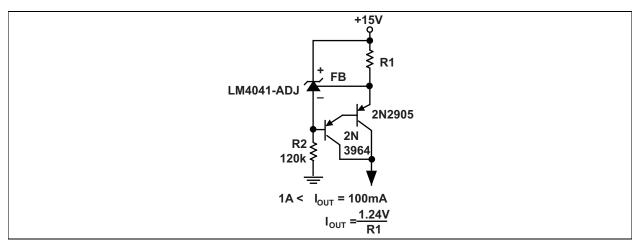


FIGURE 5-8: Current Source.

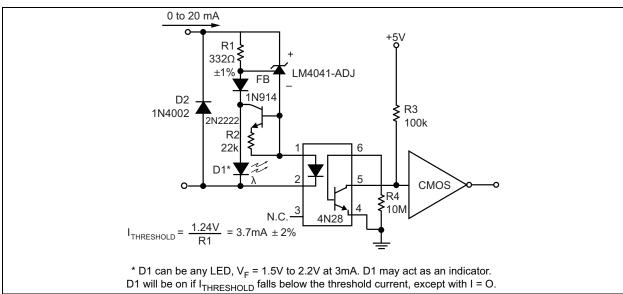
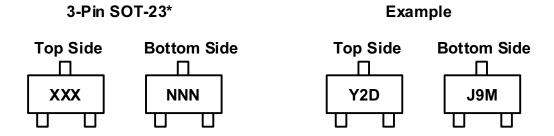


FIGURE 5-9: Precision Floating Current Detector.

6.0 PACKAGING INFORMATION

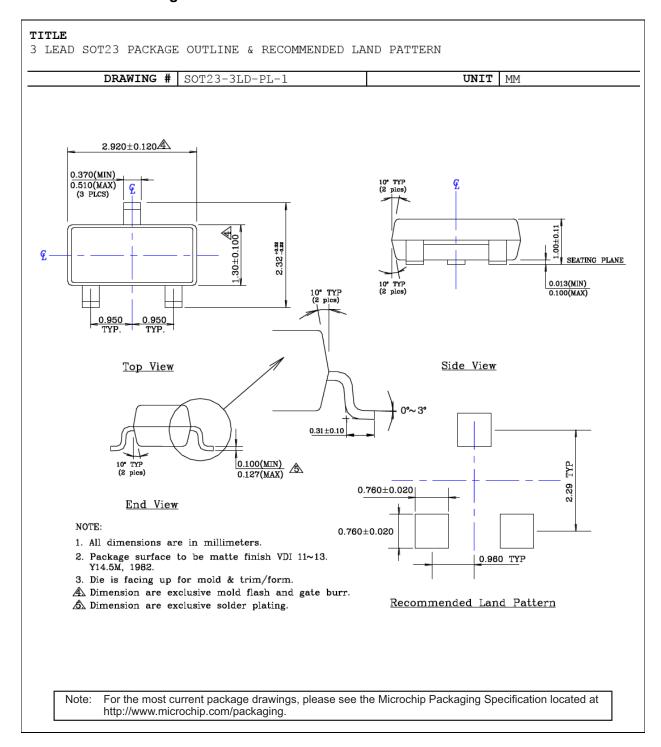
6.1 Package Marking Information



Device	Top Side Marking
LM4040CYM3-2.5-TR	Y2C
LM4040CYM3-4.1-TR	Y4C
LM4040CYM3-5.0-TR	Y5C
LM4040DYM3-2.5-TR	Y2D
LM4040DYM3-4.1-TR	Y4D
LM4040DYM3-5.0-TR	Y5D
LM4041CYM3-ADJ-TR	YAC
LM4041CYM3-1.2-TR	Y1C
LM4041DYM3-ADJ-TR	YAD
LM4041DYM3-1.2-TR	Y1D

Legend	: XXX Y YY WW NNN (e3) *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC® designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle)
Note:	be carried characters the corpor	nt the full Microchip part number cannot be marked on one line, it will dover to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. (_) and/or Overbar (_) symbol may not be to scale.

3-Lead SOT-23 Package Outline and Recommended Land Pattern



NOTES:

APPENDIX A: REVISION HISTORY

Revision A (April 2017)

- Converted Micrel data sheet LM4040/LM4041 to Microchip DS20005757A.
- Minor text changes throughout.
- Updated temperature information in all Electrical Characteristics tables to better reflect which values are valid for T_A = +25°C.

Revision B (July 2018)

- Corrected part number for Reverse Current in Operating Ratings ‡ to LM4041-ADJ.
- Updated Section 6.1 "Package Marking Information" drawing and information.
- Updated information in Product Identification System.
- Updated "Reverse-Breakdown Voltage Change with Operating Current Change" conditions for LM4041-1.2 Electrical Characteristics (Note 1) and LM4041-ADJ Electrical Characteristics (Note 1).

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u> </u>	Examples:
	racy, Temperature Package Voltage Media rature Range Type	a) LM4040CYM3-2.5-TR: LM4040, ±0.5%, 100 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 2.500V, 3,000/Reel
Device:	LM4040: Precision Micropower Shunt Voltage Reference LM4041: Precision Micropower Shunt Voltage Reference	b) LM4040CYM3-4.1-TR: LM4040, ±0.5%, 100 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 4.096V, 3,000/Reel
Accuracy, Temp. Coefficient:	C = ±0.5%, 100 ppm/°C D = ±1.0%, 150 ppm/°C	c) LM4040CYM3-5.0-TR: LM4040, ±0.5%, 100 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 5.000V, 3,000/Reel
Temperature Range:	Y = -40°C to +85°C (Industrial)	d) LM4040DYM3-2.5-TR: LM4040, ±1.0%, 150 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 2.500V, 3,000/Reel
Package: Voltage:	M3 = 3-Lead SOT-23 -2.5 = 2.500V -4.1 = 4.096V	e) LM4040DYM3-4.1-TR: LM4040, ±1.0%, 150 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 4.096V, 3,000/Reel
Media Type	-5.0 = 5.000V -1.2 = 1.225V (LM4041 Only) ADJ = 1.24V to 10V (LM4041 Only) TR = 3,000/Reel	f) LM4040DYM3-5.0-TR: LM4040, ±1.0%, 150 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 5.000V, 3,000/Reel
тиеша туре	- 5,000/Neer	g) LM4041CYM3-ADJ-TR: LM4041, ±0.5%, 100 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 1.24V to 10V, 3,000/Reel
		h) LM4041CYM3-1.2-TR: LM4041, ±0.5%, 100 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 1.225V, 3,000/Reel
		i) LM4041DYM3-ADJ-TR: LM4041, ±1.0%, 150 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 1.24V to 10V, 3,000/Reel
		j) LM4041DYM3-1.2-TR: LM4041, ±1.0%, 150 ppm/°C, -40°C to +85°C Temp. Range, 3-Lead SOT-23, 1.225V, 3,000/Reel
		Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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